## LM5046 Based Eighth Brick Reference Design

## Introduction

The LM5046 reference board is designed in the telecom in－ dustry standard one－eighth brick footprint based on the phase－shifted full－bridge topology．This board is for reference only and is intended to demonstrate the capability of the LM5046．Hardware is not provided for evaluation．Please re－ fer to AN2115 for LM5046 evaluation board．
The performance of the reference board is as follows：
－Input operating range： 36 V to 75 V
－Output voltage： 12 V
－Measured efficiency at 48 V ： $92 \%$＠10A
－Frequency of operation： 420 kHz
－Board size： $2.28 \times 0.89 \times 0.4$ inches
－Load Regulation：0．2\％
－Line Regulation：0．1\％
－Line UVLO（ $34 \mathrm{~V} / 32 \mathrm{~V}$ on／off）
－Hiccup Mode Current Limit
The printed circuit board consists of 10 layers； 2 ounce copper outer layers and 3 ounce copper inner layers on FR4 material with a total thickness of 0.12 inches．The unit is designed for continuous operation at rated load at $\angle 40^{\circ} \mathrm{C}$ and a minimum airflow of 300 LFM at full load．

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## Theory of Operation

The Phase－Shifted Full－Bridge（PSFB）topology is a deriva－ tive of the classic full－bridge topology．When tuned appropri－ ately the PSFB topology achieves zero voltage switching （ZVS）of the primary FETs while maintaining constant switch－ ing frequency．The ZVS feature is highly desirable as it re－ duces both the switching losses and EMI emissions．The figure below illustrates the circuit arrangement for the PSFB topology．The power transfer mode of the PSFB topology is similar to the hard switching full－bridge i．e．，when the FETs in the diagonal of the bridge are turned－on（Q1 \＆Q3 or Q2 \＆ Q4），a power transfer cycle is initiated．At the end of the power transfer cycle，PWM turns off the switch Q3 or Q4 depending on the phase with a pulse width determined by the input and output voltages and the transformer turns ratio．In the free－ wheel mode，unlike the classic full－bridge where all the four primary FETs are off，in the PSFB topology the primary of the power transformer is shorted by activating either both the top FETs（Q1 and Q4）or both the bottom FETs（Q2 and Q3）al－ ternatively．In a PSFB topology，the primary switches are turned on alternatively energizing the windings in such a way that the flux swings back and forth in the first and the third quadrants of the B－H curve．The use of two quadrants allows better utilization of the core resulting in a smaller core volume compared to the single－ended topologies．



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Then the SR output duty cycle is gradually increased to prevent output voltage disturbances due to the difference in the voltage drop between the body diode and the channel resistance of the synchronous MOSFETs. Feedback from the output is processed by an amplifier and reference, generating an error voltage, which is coupled back to the primary side control through an opto-coupler. The LM5046 evaluation board employs peak current mode control and a standard "type II" network is used for the compensator.

## Performance Characteristics

Once the circuit is powered up and running normally, the output voltage is regulated to 12 V with the accuracy determined by the feedback resistors and the voltage reference. The frequency of operation is selected to be 420 kHz , which is a good comprise between board size and efficiency. Please refer to the Figure 1 for efficiency curves.


30152403
FIGURE 1. Reference Board Efficiency
Figure 2 shows the output voltage during a typical start-up with a 48 V input and a load of 12 A . There is no overshoot during start-up.


## Conditions: Input Voltage $=48 \mathrm{~V}$

Output Current=12A
Trace 1: Output Voltage Volts/div=5V
Horizontal Resolution $=1.0 \mathrm{~ms} / \mathrm{div}$
FIGURE 2. Soft-Start

Figure 3 shows typical transient response on the reference board when the load current is switched from 5A to 10A and back to $5 A$. There is minimal output voltage droop and overshoot during the sudden change in output current shown by the lower trace.


30152405
Conditions: Input Voltage $=48 \mathrm{~V}$
Output Current=5A to 10A to 5A
Upper Trace: Output Voltage Volts/div=500mV
Horizontal Resolution=200 $\mu \mathrm{s} /$ div
FIGURE 3. Transient Response
Figure 4 shows typical output ripple seen directly across the output capacitor, for an input voltage of 48 V and a load of 12 A . This waveform is typical of most loads and input voltages.


Conditions: Input Voltage=48V
Output Current=12A
Bandwidth Limit=20 MHz
Trace 1: Output Voltage $100 \mathrm{mV} / \mathrm{div}$
Horizontal Resolution=2 $\mu \mathrm{s} /$ div
FIGURE 4. Output Ripple

Figure 5 and Figure 6 show the typical SW node voltage waveforms with a 25A load. Figure 5 shows an input voltage represents an input voltage of 48 V and Figure 6 represents an input voltage of 75 V .


30152407
Conditions: Input Voltage=48V
Output Current=10A
Trace 1: SW1 Node Q2 Drain Voltage Volts/div=20V
Trace 2: SW2 Node Q3 Drain Voltage Volts/div=20V
Horizontal Resolution $=1 \mu \mathrm{~s} / \mathrm{div}$
FIGURE 5. 48V Switch Node Waveforms


Conditions: Input Voltage=75V
Output Current=10A
Trace 1: SW1 Node Q2 Drain Voltage Volts/div=20V
Trace 2: SW2 Node Q3 Drain Voltage Volts/div=20V
Horizontal Resolution=1 $\mu \mathrm{s} / \mathrm{div}$
FIGURE 6. 75V Switch Node Waveforms

Figure 7 shows a typical startup of the LM5045 into a 6V prebiased load.


30152409
Conditions: Input Voltage $=48 \mathrm{~V}$, Output Pre-Bias $=6 \mathrm{~V}$
Trace 1 (Channel 1): Output Voltage Volts/div=5V
Trace 2 (Channel 2): SR gate Volage Volts/Div=5V
Trace 3 (Channel 3): Output Current Amps/div=200mA
Horizontal Resolution=2.0 ms/div
FIGURE 7. Soft-Start into a 6V Pre-Biased Output
Figure 8 shows the output current de-rating on the reference board at 48 V input.


FIGURE 8. Load Current vs. Air Flow
LM5046 Based Eight Brick Reference Board Schematic

## Bill of Materials

| Designator | Description | Manufacturer | Part Number |
| :---: | :---: | :---: | :---: |
| C1, C2, C3 | Ceramic, 2.2uF, X7R, 100V, 10\% | MuRata | GRM32ER72A225KA35L |
| C4, C40 | Ceramic, 100pF,C0G/NP0, 50V, 5\% | TDK | C1608C0G1H101J |
| C5 | Ceramic, 2.2uF, X7R, 16V, 10\% | MuRata | GRM21BR71C225KA12L |
| C6, C13 | CAP, CERM, 3300pF, 250V, +/-10\%, X7R, 0603 | MuRata | GRM188R72A332MA01D |
| C7, C9 | Ceramic, 1uF, X7R, 50V, 10\% | MuRata | GRM21BR71H105KA12L |
| C11 | Ceramic,1uF, X7R, 16V, 10\% | TDK | C1608X7R1C105K |
| C12, C15, C21, C32 | Ceramic, 0.1uF,X7R, 25V, $10 \%$ | AVX | 06033C104KAT2A |
| C14 | CAP, CERM, 0.1uF, 100V, +/-10\%, X7R, 0603 | MuRata | GRM18872A104KA |
| C17 | CAP, TANT, 150uF, 16V, +/-10\%, 0.085 ohm, 7343-31 SMD | Kemet | T495D157K016ATE085 |
| C18, C19 | Ceramic, 47uF,X5R, 16V, 20\% | MuRata | GRM32ER61C476ME15L |
| C22 | CAP, CERM, 0.022uF, 16V, +/-10\%, X7R, 0402 | TDK | C1005X7R1C223K |
| C24 | Ceramic, 0.1uF, X5R, 6.3V, 10\% | TDK | C1005X5R0J104K |
| C25, C33, C37 | CAP, CERM, 0.01uF, 16V, +/-10\%, X7R, 0402 | TDK | C1005X7R1C103K |
| C26 | CAP, CERM, 1uF, 16V, +/-20\%, X7R, 0805 | MuRata | GRM21BR71C105MA01L |
| C27, C35 | CAP, CERM, 1uF, 16V, +/-10\%, X7R, 0603 | MuRata | GRM188R71C105KA12D |
| C29 | CAP, CERM, 47pF, 50V, +/-5\%, C0G/NP0, 0402 | MuRata | GRM1555C1H470JZ01 |
| C31 | CAP CER 33000PF 16V X7R 0402 | TDK | C1005X7R1C333K |
| C34, C36 | Ceramic, 1000pF, C0G/NP0, 25V, $5 \%$ | TDK | C1005C0G1E102J |
| C38 | CAP CER .47uF 6.3V X5R 0402 | TDK | C1005X5R0J474M |
| D1 | Diode, Ultrafast, 100V, 0.25A, SOD-323 | NXP Semiconductor | BAS316,115 |
| D2 | Diode, Zener, 8.2V, 500 mW , SOD-123 | Central Semiconductor | CMHZ4694 |
| D3, D7 | Diode Switching Array 90V SOT363 | NXP | BAV756S,115 |
| D5 | Diode, Zener, 5.1V, 500mW, SOD-123 | Central Semiconductor | CMHZ4689 |
| D8, D12 | $\mathrm{Vr}=100 \mathrm{~V}$, $\mathrm{lo}=1 \mathrm{~A}, \mathrm{Vf}=0.77 \mathrm{~V}$ | Diodes Inc. | DFLS1100-7 |
| D11 | 11V SMT Zener Diode | Central Semiconductor | CMHZ4698 |
| D16 | Diode, Schottky, 45V, 0.1A, SOD-523 | Diodes Inc. | SDM10U45-7-F |
| D17 | Diode, Zener, 4.7V, 200mW, SOD-323 | Central Semiconductor | CMDZ4L7 |
| L2 | Inductor, Flat Wire, Ferrite, 3.0uH, 12A, 0.0048 ohm, SMD | Epcos Inc | B82559A0302A013 |
| P1, P2, P3 | PCB Pin | Mill-Max | 3104-2-00-34-00-00-08-0 |
| P4, P7 | Conn Pin Nail-Head L = 610" GOLD | Mill-Max | 6142-0-00-15-00-00-33-0 |
| Q1, Q3 | NPN, 1A, 45V, Transistor, NPN, 45V, 1A, SOT-89 | Diodes Inc. | FCX690BTA |
| Q2 | PNP, 0.2A, 40V | Central Semiconductor | CMPT3906 |
| Q4, Q10 | MOSFET N-CH D-S 100V 8-SOIC | Vishay | SIR882DP-T1-GE3 |
| Q6, Q7, Q8, Q9 | MOSFET, N-CH, 100V, 28A, PG-TSDSON-8 | Infineon Technologies | BSZ160N10NS3 G |
| R1, R4 | RES 0805, 5.1k, 5\%, 0.125W | Panasonic | ERJ-6GEYJ512V |
| R2, R24, R33, R36 | RES 0402, 10k,1\%, 0.063W | Vishay-Dale | CRCW040210k0FKED |
| R5 | RES, 1.00k ohm, 1\%, 0.1W, 0603 | Vishay-Dale | CRCW06031K00FKEA |
| R6 | RES 100k, 1\%, 0.125W | Vishay-Dale | CRCW0805100KFKEA |
| R7 | RES, 2.61k ohm, 1\%, 0.063W, 0402 | Vishay-Dale | CRCW04022K61FKED |
| R8 | RES 20 ohm, 0805, 5\%, 0.125W | Panasonic | ERJ-6GEYJ200V |
| R9 | RES, 1.65k ohm, 1\%, 0.063W, 0402 | Vishay-Dale | CRCW04021K65FKED |
| R13 | RES, 6.04k ohm, 1\%, 0.063W, 0402 | Vishay-Dale | CRCW04026K04FKED |
| R14 | RES 24k, 5\%, 0.063W | Vishay-Dale | CRCW040224k0JNED |
| R15 | RES, 30.1k ohm, 1\%, 0.063W, 0402 | Vishay-Dale | CRCW040230K1FKED |
| R16, R18 | RES, 499 ohm, 1\%, 0.063W, 0402 | Vishay-Dale | CRCW0402499RFKED |
| R37 | RES 0 ohm 5\%, 0.063W | Vishay-Dale | CRCW04020000Z0ED |


| R23 | RES, $17.40 h m, 1 \%, 0.063 \mathrm{~W}, 0402$ | Vishay-Dale | CRCW040217R4FKED |
| :--- | :--- | :--- | :--- |
| R27 | RES, 47 ohm, $5 \%, 0.25 \mathrm{~W}, 0603$ | Vishay-Dale | CRCW060347R0JNEA |
| R28 | RES, 7.5 k ohm, $5 \%, 0.063 \mathrm{~W}, 0402$ | Vishay-Dale | CRCW04027K50JNED |
| R30 | RES 1.82 k ohm, $1 \%, 0.063 \mathrm{~W}$ | Vishay-Dale | CRCW04021k82FKED |
| R32 | RES 100 ohm, $1 \%, 0.063 \mathrm{~W}$ | Vishay-Dale | CRCW0402100RFKED |
| R22 | RES $30.1 \mathrm{k} \mathrm{ohm} 1 \%,, 0.063 \mathrm{~W}$ | Vishay-Dale | CRCW040230k1FKED |
| R29 | RES 7.87 k ohm, $1 \%, 0.063 \mathrm{~W}$ | Vishay-Dale | CRCW04027k87FKED |
| R21 | RES 1.0k ohm, $1 \%, 0.063 \mathrm{~W}$ | Vishay-Dale | CRCW04021k00FKED |
| T2 | Current Sense Transformer | Ice Components | CT02-150 |
| U1 | $100 V ~ F u l l-B r i d g e ~ P W M ~ C o n t r o l l e r ~ w i t h ~ I n t e g r a t e d ~$ <br> MOSFET Drivers | National Semiconductor | LM5046SQ/NOPB |
| U2 | Dual 5A Compound Gate Driver with Negative Output <br> Voltage Capability | National Semiconductor | LM5110-1SD |
| U3 | Low Input Current, High CTR Photocoupler | NEC | PS2811-1-M-A |
| U4 | RRIO, High Output Current \& Unlimited Cap Load Op <br> Amp in SOT23-5 | National Semiconductor | LM8261M5 |
| U5 | Precision Micropower Shunt Voltage Reference | National Semiconductor | LM4040BIM3-2.5 |
| U6 | ISOPro Low-Power Dual-Channel Digital Isolator | Silicon Laboratories | Si8420BB-D-IS |

## PCB Layouts



FIGURE 9. Top Layer Assembly


30152412
FIGURE 10. Bottom Layer Assembly


30152413
FIGURE 11. Top Layer (Layer 1)



30152415
FIGURE 13. Layer 3


30152416
FIGURE 14. Layer 4


FIGURE 15. Layer 5


30152418
FIGURE 16. Layer 6


30152419
FIGURE 17. Layer 7



30152421
FIGURE 19. Layer 9


30152422
FIGURE 20. Bottom Layer (Layer 10)

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| Power Management | www.national.com/power | Green Compliance | www.national.com/quality/green |
| Switching Regulators | www.national.com/switchers | Distributors | www.national.com/contacts |
| LDOs | www.national.com/ldo | Quality and Reliability | www.national.com/quality |
| LED Lighting | www.national.com/led | Feedback/Support | www.national.com/feedback |
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